



74ALVC16245-Q100

16-bit transceiver with direction pin; 3-state

Rev. 1 — 3 June 2024

Product data sheet

1. General description

The 74ALVC16245-Q100 is a 16-bit transceiver with 3-state outputs. The device can be used as two 8-bit transceivers or one 16-bit transceiver. The device features two output enables (1OE and 2OE) each controlling eight outputs, and two send/receive (1DIR and 2DIR) inputs for direction control. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state.

Schmitt trigger action on all inputs makes the device tolerant of slow rise and fall times.

This device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE™ flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimum noise and ground bounce
- Overvoltage tolerant inputs to 5.5 V
- Direct interface with TTL levels
- I_{OFF} circuitry provides partial Power-down mode operation
- Output drive capability 50 Ω transmission lines at 85 °C
- Current drive ±24 mA at 3.0 V
- Latch-up performance exceeds 2500 mA per JESD 78 Class II.A
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
 - CDM JESD22-C101E exceeds 1000 V

3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
74ALVC16245DGG-Q100	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1

4. Functional diagram

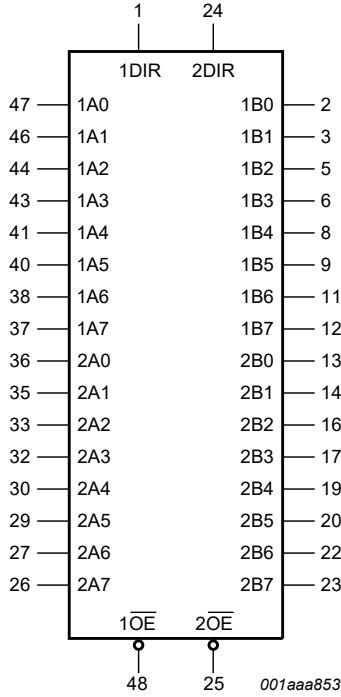


Fig. 1. Logic symbol

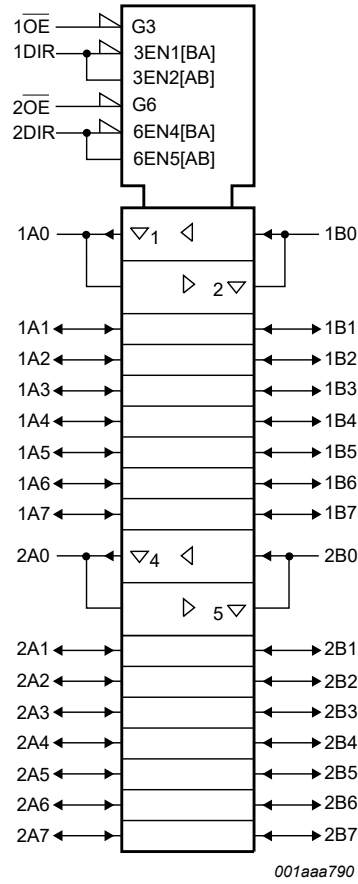


Fig. 2. IEC logic symbol

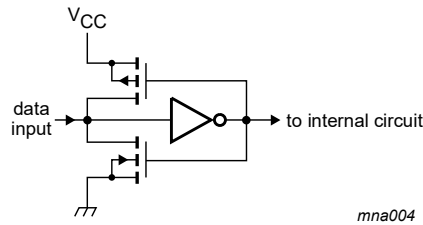


Fig. 3. Bushold circuit

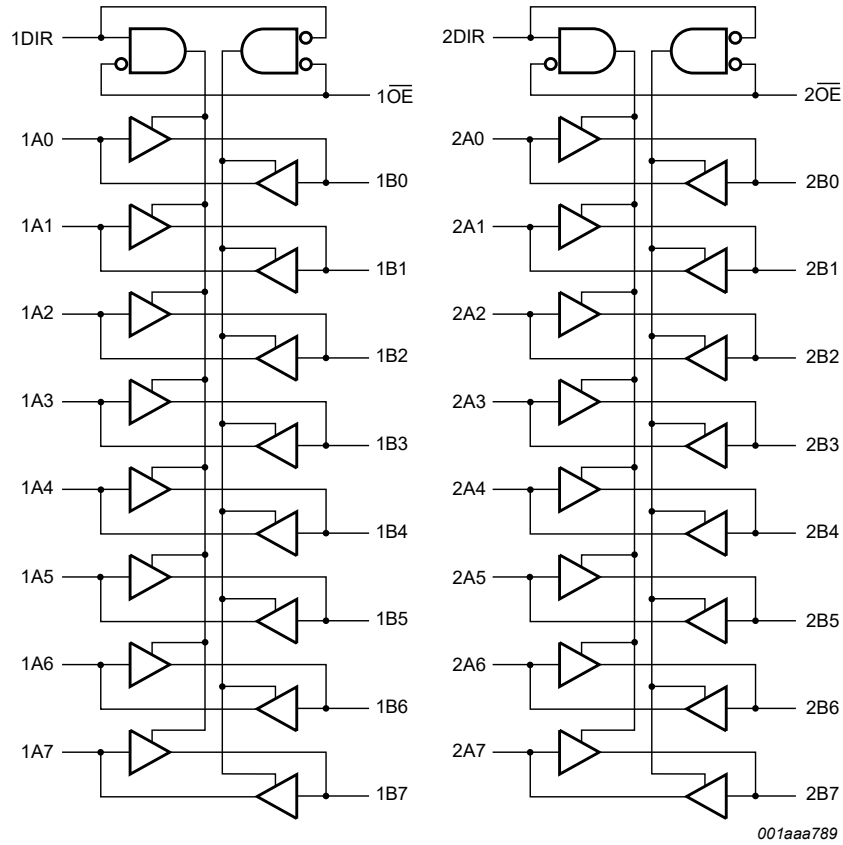
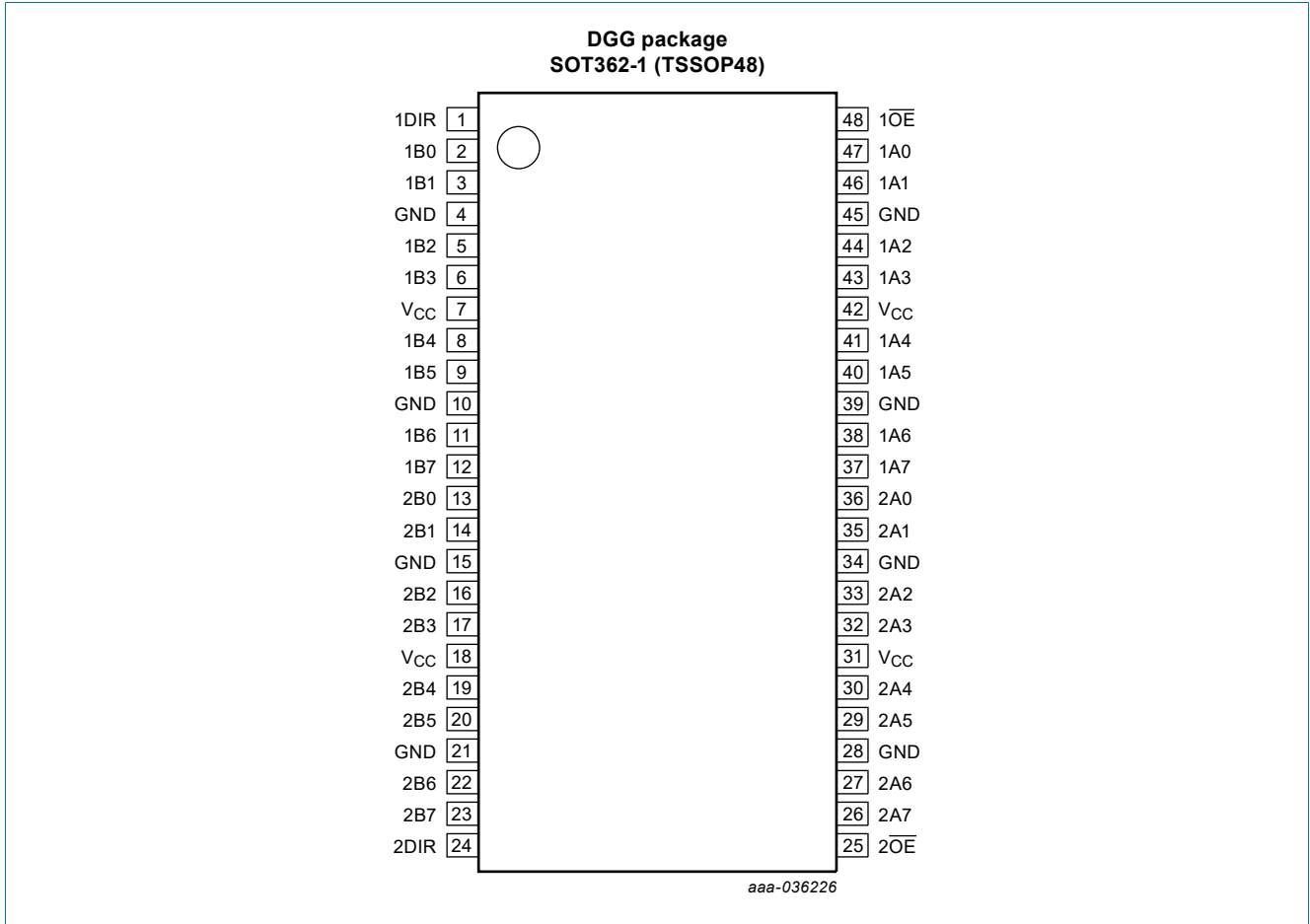


Fig. 4. Logic diagram

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control inputs
1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	2, 3, 5, 6, 8, 9, 11, 12	data output or input
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	positive supply voltage
2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	13, 14, 16, 17, 19, 20, 22, 23	data output or input
1OE, 2OE	48, 25	output enable input (active LOW)
2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	36, 35, 33, 32, 30, 29, 27, 26	data input or output
1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	47, 46, 44, 43, 41, 40, 38, 37	data input or output

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Input		Input or output	
nOE	nDIR	nAn	nBn
L	L	output nAn = nBn	input
L	H	input	output nBn = nAn
H	X	Z	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
V _I	input voltage	74ALVCH16245-Q100; data inputs [1]	-0.5	V _{CC} + 0.5	V
		74ALVC16245-Q100; data inputs [1]	-0.5	+4.6	V
		control pins [1]	-0.5	+4.6	V
V _O	output voltage	[1]	-0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
I _{OK}	output clamping current	V _O > V _{CC} or V _O < 0 V	-	±50	mA
I _O	output current	V _O = 0 V to V _{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +85 °C	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	supply voltage	maximum speed performance				
		C _L = 30 pF	2.3	-	2.7	V
		C _L = 50 pF	3.0	-	3.6	V
		low-voltage applications	1.2	-	3.6	V
V _I	input voltage		0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.3 V to 3.0 V	-	-	20	ns/V
		V _{CC} = 3.0 V to 3.6 V	-	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
V _{IH}	HIGH-level input voltage	V _{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	1.5	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.3 V to 2.7 V	-	1.2	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	1.5	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}				
		I _O = -100 µA; V _{CC} = 2.3 V to 3.6 V	V _{CC} - 0.2	V _{CC}	-	V
		I _O = -6 mA; V _{CC} = 2.3 V	V _{CC} - 0.3	V _{CC} - 0.08	-	V
		I _O = -12 mA; V _{CC} = 2.3 V	V _{CC} - 0.6	V _{CC} - 0.26	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	V _{CC} - 0.5	V _{CC} - 0.14	-	V
		I _O = -12 mA; V _{CC} = 3.0 V	V _{CC} - 0.6	V _{CC} - 0.09	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}				
		I _O = 100 µA; V _{CC} = 2.3 V to 3.6 V	-	GND	0.20	V
		I _O = 6 mA; V _{CC} = 2.3 V	-	0.07	0.40	V
		I _O = 12 mA; V _{CC} = 2.3 V	-	0.15	0.70	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	0.14	0.40	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	0.27	0.55	V
I _I	input leakage current	V _{CC} = 2.3 V to 3.6 V; V _I = V _{CC} or GND	-	0.1	5	µA
I _{OZ}	OFF-state output current	V _{CC} = 2.3 V to 3.6 V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND	-	0.1	10	µA
I _{CC}	supply current	V _{CC} = 2.3 V to 3.6 V; V _I = V _{CC} or GND; I _O = 0 A	-	0.2	40	µA
ΔI _{CC}	additional supply current	74ALVCH16245- Q100; per data I/O pin; V _{CC} = 2.3 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	150	750	µA
I _{BHL}	bus hold LOW current	V _{CC} = 2.3 V; V _I = 0.7 V [2]	45	-	-	µA
		V _{CC} = 3.0 V; V _I = 0.8 V [2]	75	150	-	µA
I _{BHH}	bus hold HIGH current	V _{CC} = 2.3 V; V _I = 1.7 V [2]	-45	-	-	µA
		V _{CC} = 3.0 V; V _I = 2.0 V [2]	-75	-175	-	µA
I _{BHLO}	bus hold LOW overdrive current	V _{CC} = 3.6 V [2]	500	-	-	µA
I _{BHHO}	bus hold HIGH overdrive current	V _{CC} = 3.6 V [2]	-500	-	-	µA
C _I	input capacitance		-	4.0	-	pF
C _{I/O}	input/output capacitance		-	8.0	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[2] Valid for data inputs of bushold parts.

10. Dynamic characteristics

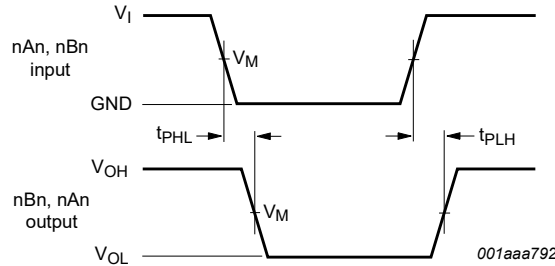
Table 7. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
t_{pd}	propagation delay	nAn to nBn; nBn to nAn; see Fig. 5 [2]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.0	3.7	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	2.1	3.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	1.9	3.0	ns
t_{en}	enable time	\overline{nOE} to nAn; \overline{nOE} to nBn; see Fig. 6 [3]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.7	5.7	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	3.0	5.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.3	4.4	ns
t_{dis}	disable time	\overline{nOE} to nAn; \overline{nOE} to nBn; see Fig. 6 [4]				
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.2	5.2	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	3.1	4.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.8	4.1	ns
C_{PD}	power dissipation capacitance	per buffer; $V_I = \text{GND to } V_{CC}$ [5]				
		outputs enabled	-	29	-	pF
		outputs disabled	-	5	-	pF

- [1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.
 Typical values for $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ are measured at $V_{CC} = 2.5 \text{ V}$.
 Typical values for $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ are measured at $V_{CC} = 3.3 \text{ V}$.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] t_{en} is the same as t_{PZL} and t_{PZH} .
- [4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz;
 f_o = output frequency in MHz;
 C_L = output load capacitance in pF;
 V_{CC} = supply voltage in Volts;
 N = total load switching outputs;
 $\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

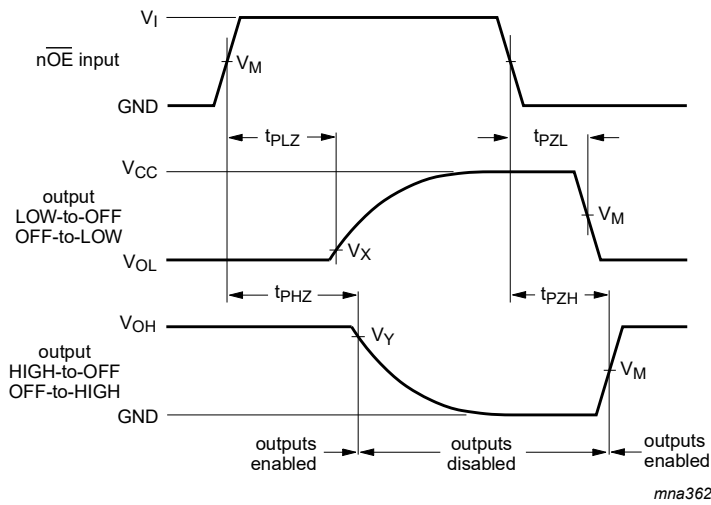
10.1. Waveforms and test circuit



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 5. Input (nAn, nBn) to output (nBn, nAn) propagation delay times



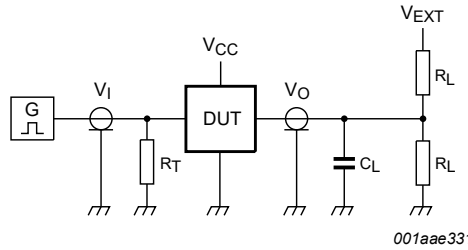
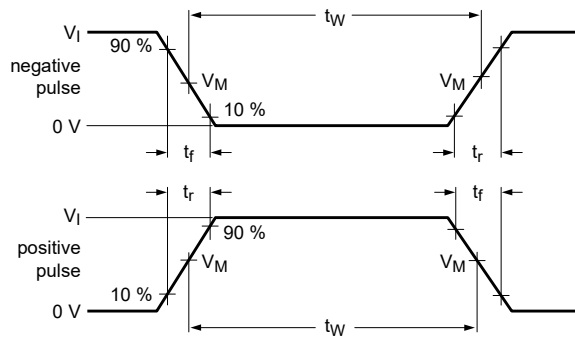
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 6. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
$< 2.7\text{ V}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
$\geq 2.7\text{ V}$	1.5 V	1.5 V	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



001aae331

Test data is given in [Table 9](#).

Definitions test circuit:

R_L = Load resistance.

C_L = Load capacitance includes jig and probe capacitance.

R_T = Termination resistance should be equal to Z_o of pulse generator.

V_{EXT} = Test voltage for switching times.

Fig. 7. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PHZ}, t_{PZH}	t_{PLZ}, t_{PZL}
< 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500 Ω	open	GND	$2 \times V_{CC}$
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	$2 \times V_{CC}$

11. Package outline

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

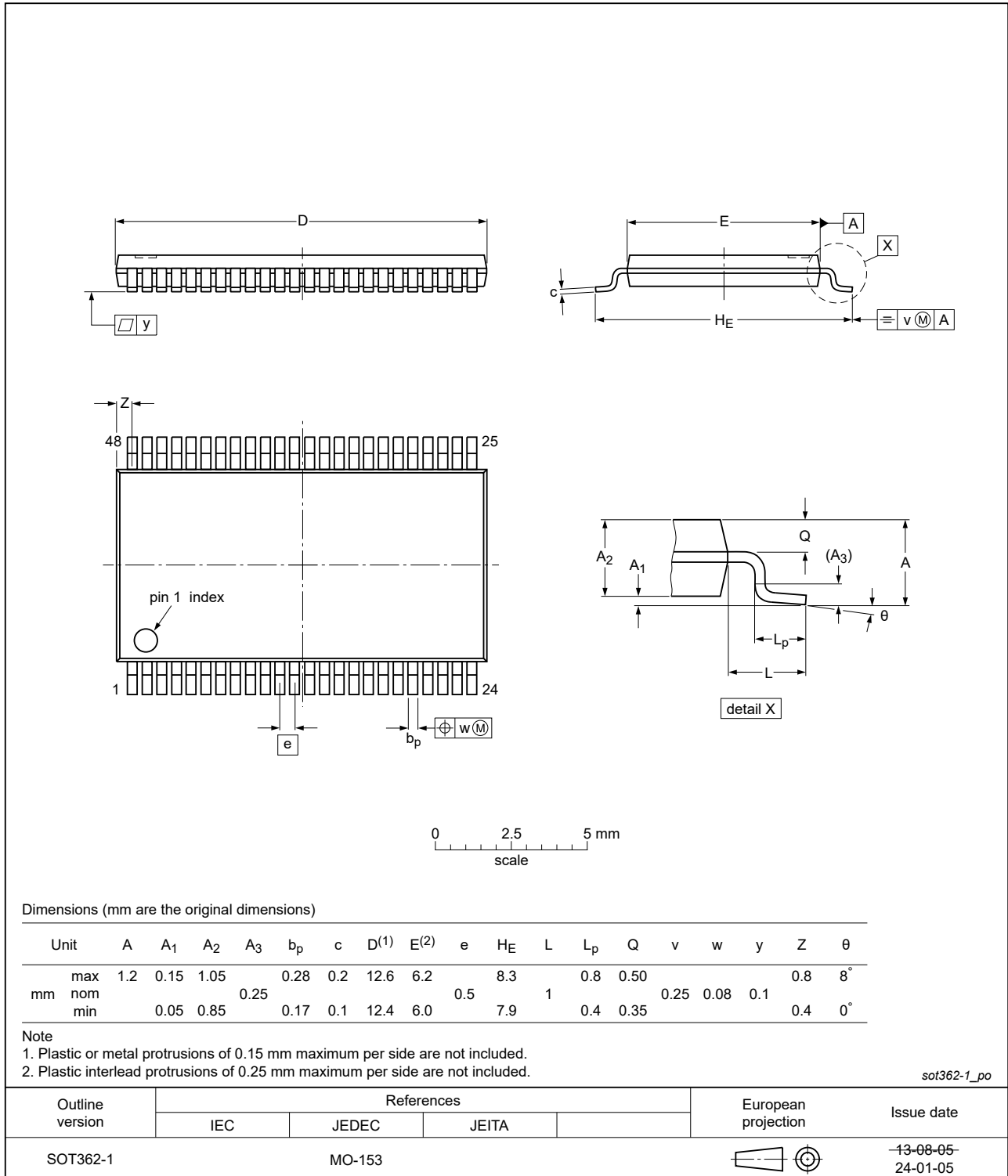


Fig. 8. Package outline SOT362-1 (TSSOP48)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVC16245_Q100 v.1	20240603	Product data sheet	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Date of release: 3 June 2024